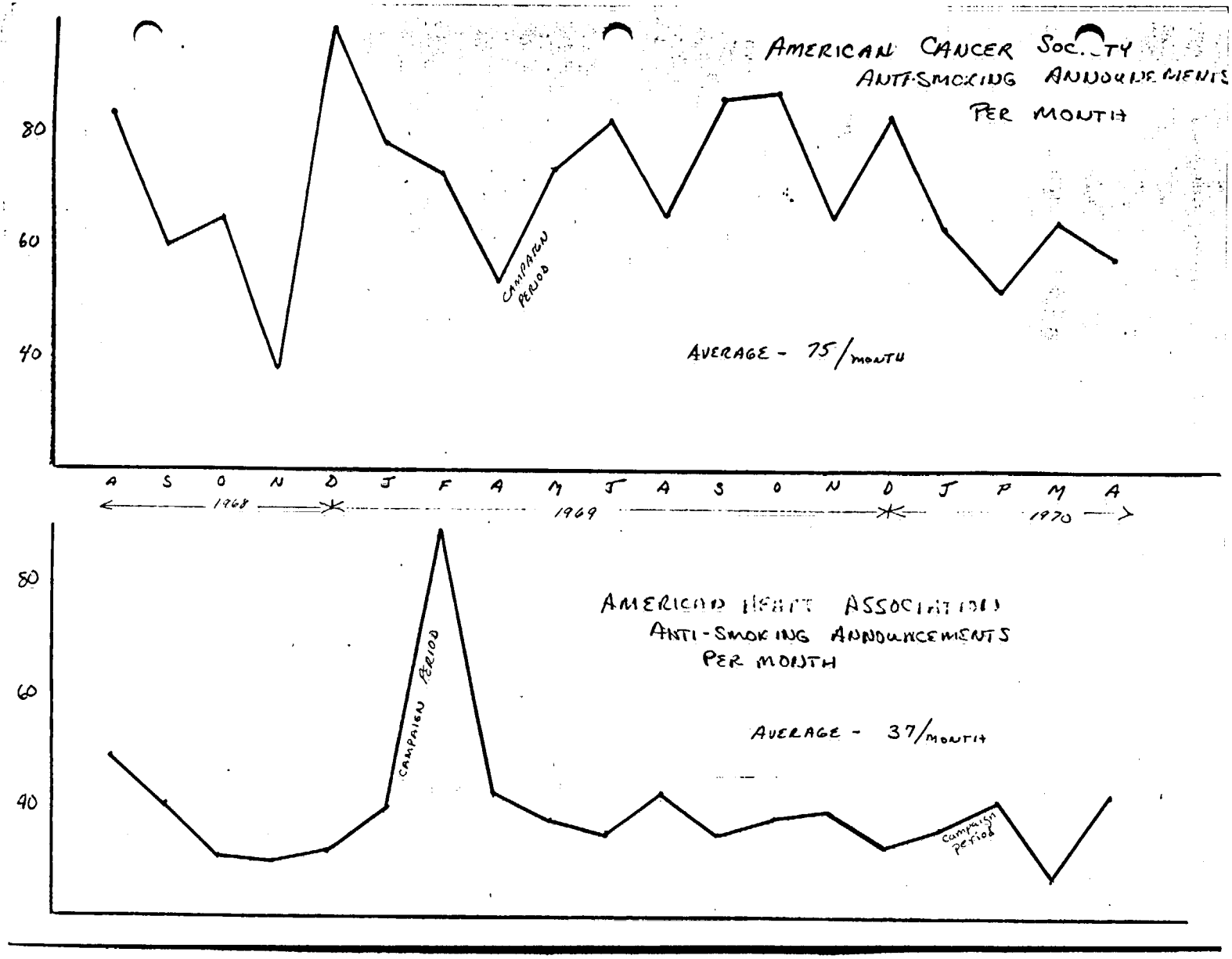
Source: https://www.industrydocuments.ucsf.edu/docs/stn10000



1002421538